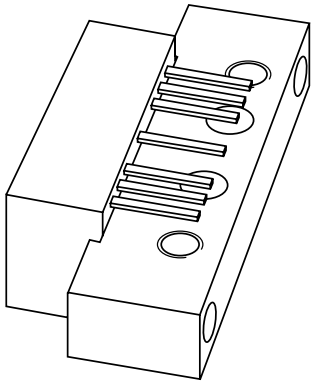
DATA SHEET



CGY887A

860 MHz, 25.5 dB gain push-pull amplifier

Product specification
Supersedes data of 2001 Oct 25

2002 Apr 18

Philips Semiconductors

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860 MHz, 25.5 dB gain push-pull amplifier CGY887A

FEATURES

- High gain
- Superior linearity
- Extremely low noise
- Rugged construction
- Gold metallization ensures excellent reliability.

APPLICATIONS

- CATV systems operating in the 40 to 870 MHz frequency range.

DESCRIPTION

Hybrid dynamic range amplifier module in a SOT115J package operating with a voltage supply of 24 V (DC), employing both GaAs and Si dies.

PINNING - SOT115J

PIN	DESCRIPTION
1	input
2	common
3	common
5	$+V_B$
7	common
8	common
9	output

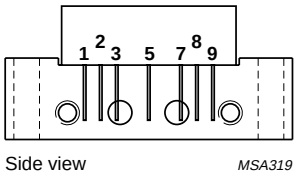


Fig.1 Simplified outline.

QUICK REFERENCE DATA

SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G_p	power gain	f = 50 MHz	25.2	25.8	dB
		f = 870 MHz	25.7	27	dB
I_{tot}	total current consumption (DC)	V_B = 24 V	–	240	mA

LIMITING VALUES

In accordance with the Absolute Maximum Rating System (IEC 60134).

SYMBOL	PARAMETER	MIN.	MAX.	UNIT
V_i	RF input voltage	–	75	dBmV
T_{stg}	storage temperature	–40	+100	°C
T_{mb}	operating mounting base temperature	–20	+100	°C

CHARACTERISTICS

Bandwidth 40 to 870 MHz; V_B = 24 V; T_{case} = 30 °C; $Z_S = Z_L$ = 75 Ω.

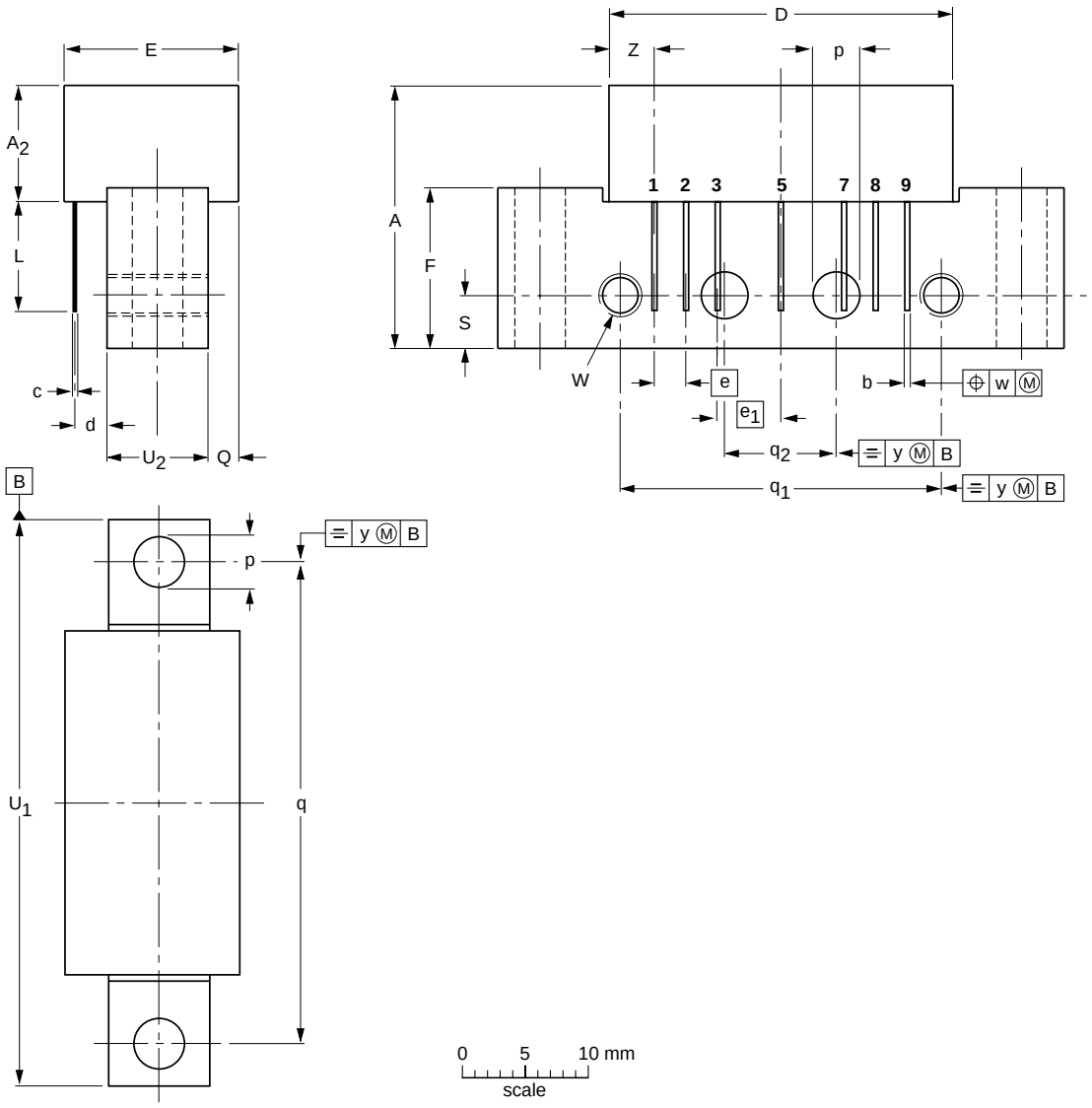
SYMBOL	PARAMETER	CONDITIONS	MIN.	MAX.	UNIT
G_p	power gain	f = 50 MHz	25.2	25.8	dB
		f = 870 MHz	25.7	27	dB
SL	straight line	f = 40 to 870 MHz	0.5	1.4	dB
FL	flatness of frequency response	f = 40 to 870 MHz	–	±0.5	dB
s_{11}	input return losses	f = 40 to 80 MHz	20	–	dB
		f = 80 to 160 MHz	20	–	dB
		f = 160 to 320 MHz	20	–	dB
		f = 320 to 550 MHz	20	–	dB
		f = 550 to 640 MHz	19	–	dB
		f = 640 to 750 MHz	17	–	dB
		f = 750 to 870 MHz	17	–	dB
s_{22}	output return losses	f = 40 to 80 MHz	21	–	dB
		f = 80 to 160 MHz	19	–	dB
		f = 160 to 320 MHz	17	–	dB
		f = 320 to 550 MHz	16	–	dB
		f = 550 to 640 MHz	16	–	dB
		f = 640 to 750 MHz	16	–	dB
		f = 750 to 870 MHz	16	–	dB
s_{21}	phase response	f = 50 MHz	–45	+45	deg
CTB	composite triple beat	129 channels flat; V_o = 40 dBmV; measured at 745.25 MHz	–	–62	dB
X_{mod}	cross modulation	129 channels flat; V_o = 40 dBmV; measured at 55.25 MHz	–	–56	dB
CSO	composite second order distortion	129 channels flat; V_o = 40 dBmV; measured at 860.5 MHz	–	–59	dB
		129 channels flat; V_o = 40 dBmV; measured at 150 MHz	–	–69	dB
d_2	second order distortion	note 1	–	–67	dB
V_o	output voltage	d_{im} = –60 dB; note 2	62	–	dBmV
NF	noise figure	f = 50 MHz	–	5.5	dB
		f = 100 to 870MHz	–	5	dB
I_{tot}	total current consumption (DC)	note 3	–	240	mA

Notes

1. f_p = 55.25 MHz; V_p = 50 dBmV;
   f_q = 805.25 MHz; V_q = 50 dBmV;
   measured at $f_p + f_q$ = 860.5 MHz.
2. Measured according DIN45004B:
   f_p = 851.25 MHz; $V_p = V_o$;
   f_q = 858.25 MHz; $V_q = V_o$ –6 dB;
   f_r = 860.25 MHz; $V_r = V_o$ –6 dB;
   measured at $f_p + f_q - f_r$ = 849.25 MHz.
3. The module normally operates at V_B = 24 V, but is able to withstand supply transients up to 30 V.

PACKAGE OUTLINE

Rectangular single-ended package; aluminium flange; 2 vertical mounting holes; 2 x 6-32 UNC and 2 extra horizontal mounting holes; 7 gold-plated in-line leads **SOT115J**



DIMENSIONS (mm are the original dimensions)

UNIT	A max.	A_2 max.	b	c	D max.	d max.	E max.	e	e_1	F	L min.	p	Q max.	q	q_1	q_2	S	U_1 max.	U_2	W	w	y	Z max.
mm	20.8	9.1	0.51 0.38	0.25	27.2	2.54	13.75	2.54	5.08	12.7	8.8	4.15 3.85	2.4	38.1	25.4	10.2	4.2	44.75	8	6-32 UNC	0.25	0.1	3.8

OUTLINE VERSION	REFERENCES				EUROPEAN PROJECTION	ISSUE DATE
	IEC	JEDEC	EIAJ			
SOT115J						99-02-06

DATA SHEET STATUS

DATA SHEET STATUS[1]	PRODUCT STATUS[2]	DEFINITIONS
Objective data	Development	This data sheet contains data from the objective specification for product development. Philips Semiconductors reserves the right to change the specification in any manner without notice.
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